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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/589,275	08/10/2006	Christophe Regnier	361919-1024	5699
32914 7590 11/24/2009 GARDERE WYNNE SEWELL LLP INTELLECTUAL PROPERTY SECTION 3000 THANKSGIVING TOWER 1601 ELM ST DALLAS, TX 75201-4761			EXAMINER IM, JUNGHWAN M	
			ART UNIT 2811	PAPER NUMBER
			MAIL DATE 11/24/2009	DELIVERY MODE PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Office Action Summary

Application No.

10/589,275

Applicant(s)

REGNIER ET AL.

Examiner

JUNGHWAN M. IM

Art Unit

2811

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --
Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 14 September 2009.
2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-11, 14, 15, 17-21 and 33-43 is/are pending in the application.
4a) Of the above claim(s) 33-43 is/are withdrawn from consideration.
5) ☒ Claim(s) 1-11 is/are allowed.
6) ☒ Claim(s) 14, 15 and 17-21 is/are rejected.
7) ☐ Claim(s) _____ is/are objected to.
8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
10) ☒ The drawing(s) filed on 10 August 2006 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☒ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
a) ☒ All b) ☐ Some * c) ☐ None of:
1. ☒ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. _____.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- 1) ☒ Notice of References Cited (PTO-892)
2) ☐ Notice of Draftperson's Patent Drawing Review (PTO-948)
3) ☒ Information Disclosure Statement(s) (PTO/SB/08)
Paper No(s)/Mail Date 5/7/2007.
4) ☐ Interview Summary (PTO-413)
Paper No(s)/Mail Date _____.
5) ☐ Notice of Informal Patent Application
6) ☐ Other: _____

DETAILED ACTION

Election/Restrictions

Applicant's election without traverse of claims 1-11, 14-15, 17-21 and 33-43 in the reply filed on 9/14/2009 is acknowledged. However, claims 1-11, 14-15, 17-21 will be examined since claims 33-43 reflect non-elected embodiment Fig.'s 6-8.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 14, 15 and 17-21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Wilbarg et al. (US 5296408), hereinafter Wilbarg in view of You et al. (US 6147000), hereinafter You and Eldridge (US 6140200).

Regarding claims 14, 15 and 20, Fig.'s 2A-2D of Wilbarg show a process for forming an integrated circuit, comprising:

- forming a cavity in an absorbing material layer (10; Si wafer);
- depositing a sacrificial layer (14) in the cavity,; and
- heating the integrated circuit to a temperature sufficient to cause the sacrificial layer to be absorbed into the absorbing material layer and leave a void.

Fig.'s 2A-2D of Wilbarg show most aspects of the instant invention except the sacrificial layer having a melting point in excess of a temperature used for integrated

circuit component fabrication heating and filling the cavity with a fill material, therefore, leaving a void between the absorbing material layer and the fill material. You discloses a sacrificial material (Ta, Cr) having a melting point in excess of a temperature used for integrated circuit component fabrication heating (col. 3, lines 33-40). It would have been obvious to one of ordinary skill in the art at the time of the invention was made to incorporate the teachings of You into the device of Wilbarg in order to have the sacrificial material such as Ta, Cr with a melting point in excess of a temperature to prevent the diffusion to the substrate.

The combination of Wilbarg/You shows most aspects of the invention except filling the cavity with a fill material, therefore, leaving a void between the absorbing material layer and the fill material. Fig.'s 5-6 of Eldridge show filling the cavity with a fill material (60). It would have been obvious to one of ordinary skill in the art at the time of the invention was made to incorporate the teachings of Eldridge into the device of Wilbarg/You in order to have the cavity filled with a fill material, therefore, leaving a void between the absorbing material layer and the fill material to form a capacitor.

Regarding claim 17, it is obvious that the combination of Wilbarg/You/Eldridge would show circuit component fabrication heating comprises integrated circuit heat densification since the material forming the circuit component is hardened through heating.

Regarding claim 18, it is obvious that the combination of Wilbarg/You/Eldridge would show heating comprises using the heating step to not only cause the sacrificial

layer to be absorbed but also to drive silicidation of the integrated circuit since the sacrificial material Ta reacts with the Si substrate.

Regarding claim 19, You discloses the sacrificial layer includes a material selected from the group consisting of cobalt, nickel, titanium, tantalum, tungsten, molybdenum, silver, gold, iron and chromium (col. 3, lines 33-40).

Regarding claim 21, Fig. 6 of Eldridge shows the fill layer comprises an intermediate layer (66) and an electrically conducting layer (60).

Allowable Subject Matter

Claims 1-11 are allowed.

The following is an examiner's statement of reasons for allowance.

Prior art fails to teach or render obvious, either singularly or with combinations of elements as set forth in the claims including, a process for fabricating an electronic integrated circuit, at least the limitation of "a portion made of a sacrificial material coming into contact with one face of the part of the substrate composed of absorbing material; forming a rigid portion in fixed contact with the substrate, on one side of the portion of sacrificial material opposite to said face of the part of the substrate composed of absorbing material; and heating the circuit in order to create a volume substantially empty of material by absorption of the sacrificial material into the part of the substrate composed of absorbing material, wherein the sacrificial material has a melting point in excess of 900°C and wherein the sacrificial material is chosen so as not to cause any

material alteration of parts of the circuit in contact with the portion of sacrificial material prior to heating."

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to JUNGHWA M. IM whose telephone number is (571)272-1655. The examiner can normally be reached on MON.-FRI. 7:30AM-4:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Lynne A. Gurley can be reached on (571) 272-1670. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/Junghwa M. Im/
Examiner, Art Unit 2811

/J. M. I./
Examiner, Art Unit 2811